



## **TO-9 Packaged Laser Diode**

High Power Single-Mode and Multi-Mode SemiNex Lasers 12xx to 19xx nm

Custom Wavelengths Available Lensed Options Available

## Applications .

- OEM Medical Professional Medical
- LiDAR .

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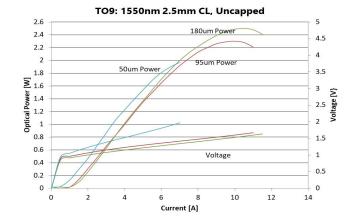
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- Military / Aerospace Illumination .

## Features

- Cost effective .
- High Output Power High Dynamic Range
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- •
- High Efficiency Standard Low Cost Package .

SemiNex delivers the highest available power at infrared wavelengths between 12xx and 19xx nm. When necessary we will further optimize the design of our InP laser chips to meet our customers' specific optical and electrical performance needs. Diodes, bars and packages are tested to meet our customer demonder the optimize of the performance demonder. to meet customer and market performance demands. Typical results and packaging options are shown. Contact SemiNex for additional details or to discuss your specific requirements.



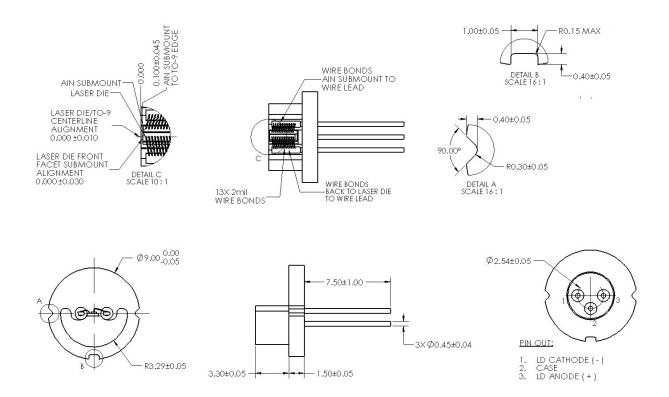






	Symbol	TO9-118	Units
Optical			
Wavelength	λ <sub>c</sub>	1550	nm (±20)
Output Power (CW)	P	1.60	watts (±10%)
Chip Cavity Length	CL	2500	μm
Emitter Width	W	95	μm
Emitter Height	Н	1	μm
Spectral Width	δλ	10	nm 3dB
Slope Efficiency	η.	0.25	W/A
Fast Axis Div.*	O_perp	28	deg FWHM
Slow Axis Div.	⊖_parallel	9	deg FWHM
Electrical			
Power Conversion Eff.	η	12	%
Operating Current	I <sub>op</sub>	8	A
Threshold Current	l <sub>th</sub>	0.5	A
Operating Voltage	V <sub>op</sub>	1.7	V
Mechanical			
Weight		1.5	g
Operating Temp.**		-40 to 60	°C
Storage Temp.		-40 to 80	°C

Specified values are rated at a constant heat sink temperature of 20°C. \*\*Specified operating conditions are based on 20C heat sink temperature. High temperature operation will reduce performance and MTTF. Unless otherwise indicated all values are nominal. Uncapped TO9 specifications assume heatsinking underneath laser chip. Capped TO9 specifications assume heatsinking only on flat surface where pins extend.



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